

## **DATASHEET**

# 1.4 mm Height Subminiature , Axial Flat Top View LED EASG2520RA1



#### **Features**

- Package in 12mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free
- The product itself will remain within RoHS compliant version

### **Descriptions**

- The EASG2520 SMD taping is much smaller than leaded components. Thus enables smaller board size. Higher packing density. Reduced storage space and finally smaller equipment to be obtained.
- Besides, light weight makes them ideal for miniature applications.
- Furthermore by automation assembly machines the accuracy is anticipated.

#### **Applications**

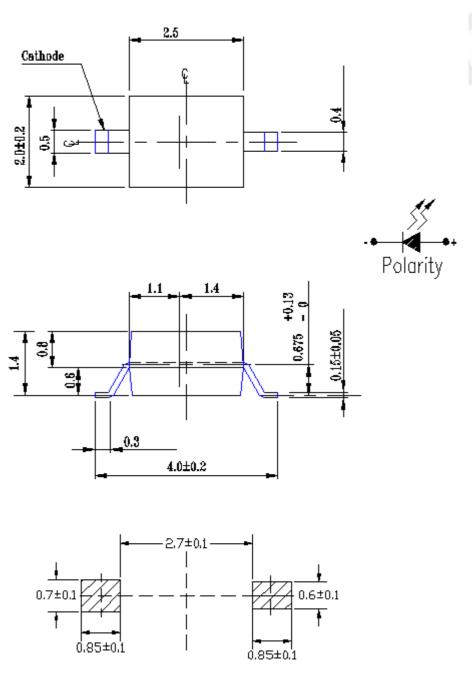
- Small indicator for indoor applications.
- Flat backlight for LCD, switches and symbols.
- Indicator and backlight in office equipment.
- Indicator and backlight for battery driven equipment.
- Indicator and backlight for audio and video equipment.
- Automotive : backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax.



## **Device Selection Guide**

David Ni	Chip	E	olor Resin Color	
Part No.	Material	Emitted Color		
EASG2520RA1	AlGaInP	Deep-Red	Water Clear	

# **Package Outline Dimensions**



**Note:** Tolerances Unless Dimension is  $\pm 0.1$ mm, Unit = mm



**Absolute Maximum Ratings (Ta=25℃)** 

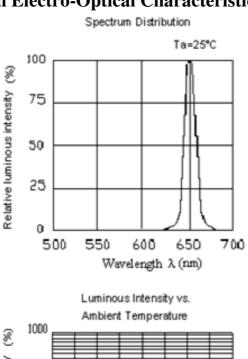
110001410 111411114111141111411114111411					
Parameter	Symbol	Rating	Unit		
Reverse Voltage	$V_R$	5	V		
Forward Current	IF	25	mA		
Peak Forward Current(Duty 1/10 @ 1KHz)	Ifp	60	mA		
Power Dissipation	Pd	60	mW		
Electrostatic Discharge(HBM)	ESD	2000	V		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$		
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\mathbb{C}$		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.			

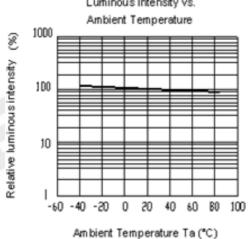
Electro-Optical Characteristics (Ta=25°C)

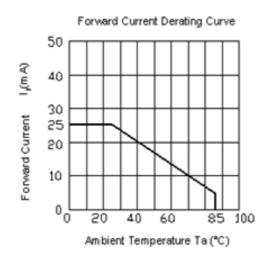
_		- /				
Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Luminous Intensity	$I_{V}$	20	27		mcd	
Viewing Angle	201/2		150		deg	
Peak Wavelength	$\lambda_{ m p}$		650		nm	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{ m d}$		639		nm	
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	$V_{F}$	1.7	2.0	2.4	V	
Reverse Current	$I_R$			10	μΑ	V <sub>R</sub> =5V

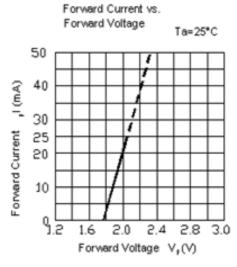


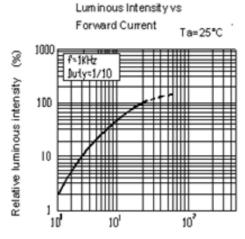
# **Typical Electro-Optical Characteristics Curves**

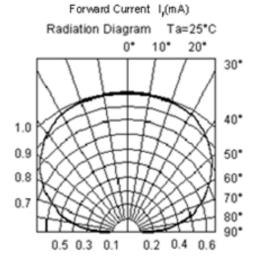














## Label explanation

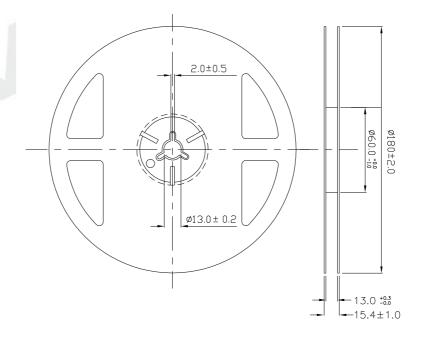
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



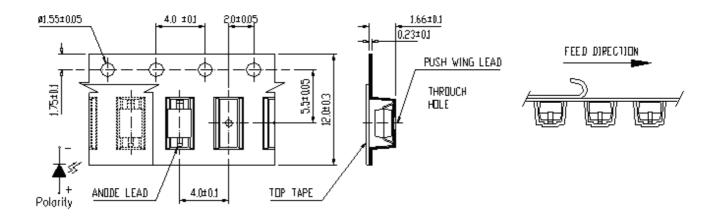
## **Reel & Carrier Tape Dimensions**



Note: The tolerances unless mentioned are  $\pm 0.1$ , unit=mm.

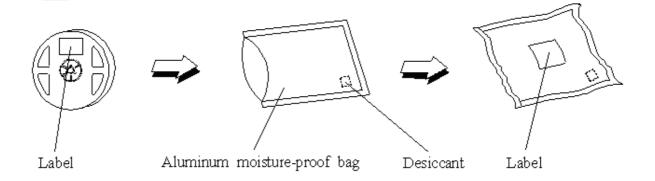


# Loaded quantity per reel 1000 PCS/reel



**Note:** Tolerances Unless Dimension is  $\pm 0.1$ mm, Unit = mm

# **Moisture Resistant Packaging**





# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level:

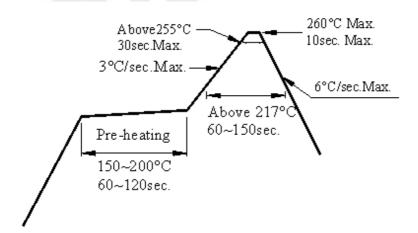
LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H:+100°C 15 min. ∫ 5 min. L:-40°C 15 min.	300 Cycles	22 Pcs.	0/1
3	Thermal Shock	H: +100°C 5 min. ∫ 10 sec. L: -10°C 5 min.	300 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 Pcs.	0/1



#### **Precautions For Use**

- Over-current-proof
   Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change ( Burn out will happen ).
- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment:  $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

## 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

